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Paper No. 07132005

JUNICHI MIMURA OKI AMERICA INC. 110 14th Street, N.W. Suite 555 Washington, DC 20005

JUL 1 4 2005

In re Application of

Ikegami Naokatsu

Application No.: 10/625544

Filed: July, 24 2003

For: METHOD OF MANUFACTURING

SEMICONDUCTORDEVICE HAVING THIN FILM SOI

STRUCTURE

WITHDRAWAL FROM ISSUE

37 CFR 1.313

The purpose of this communication is to inform you that the above-identified application is being withdrawn from issue pursuant to 37 CFR 1.313.

The application is being withdrawn from issue because of unpatentability of at least one claim.

The US Patent and Trademark Office records reveal that the issue fee has not been paid. If the issue fee has been submitted, the applicant may request a refund, or may request that the fee be credited to a deposit account. However, applicant may wait until the application is either again found allowable or held abandoned. If the application is allowed, upon receipt of a new Notice of Allowance and Fee(s) Due, applicant may request that the previously submitted issue fee be applied toward payment of the issue fee in the amount identified on the new Notice of Allowance and Fee(s) Due. If the application is abandoned, applicant may request either a refund or a credit to a Deposit Account.

Any question regarding this communication should be directed to Amir Zarabian, Supervisory Patent Examiner, at (571) 272-1852.

The above identified application is being forwarded to the examiner for prompt appropriate action, including notifying applicant of the new status of this application.

James Dwyer, Director

Technology Center 2800

Semiconductors, Electrical and Optical

Systems and Components